

MX555ABB850M000

Ultra-Low Jitter 850MHz LVDS XO

ClockWorks® FUSION

General Description

The MX555ABB850M000 is an ultra-low phase jitter XO with LVDS output optimized for high line rate applications.

Features

- 850MHz LVDS
- Typical phase noise:
 - 100fs (Integration range: 1.875MHz-20MHz)
- ±50ppm total frequency stability
- -40°C to +85°C temperature range
- Industry standard 6-Pin 5mm x 3.2mm LGA package

Absolute Maximum Ratings¹

Supply Voltage (VIN)	+4.6V
Lead Temperature (soldering, 10s)	260°C
Case Temperature	115°C
Storage Temperature (T _S) ESD Machine Model	65°C to +125°C
ESD Machine Model	200V
ESD Rating (HBM)	2kV

Operating Ratings²

Supply Voltage (VIN)	+2.375V to $+3.63V$
Ambient Temperature (TA)	40°C to $+85$ °C
Junction Thermal Resistance	
LGA (T _{IA}) Still Air	58°C/W
` JA´	

Electrical Characteristics

VDD = 2.375 - 3.63V, TA = -40°C to +85°C, outputs terminated with 100 Ohms between Q and /Q.3

Symbol	Parameter	Condition	Min.	Тур.	Max.	Units
IDD	Supply Current				90	mA
F0	Center Frequency			850		MHz
	Frequency Stability	Note 4			±50	ppm
Øj	Phase Noise	Integration Range (12kHz to 20MHz) Integration Range (1.875MHz to 20MHz)		220 100		fsRMS
Tstart	Start-Up Time				20	ms
TR/TF	Rise/Fall time		100		400	ps
	Duty Cycle		45		55	%
VOH	Output High Voltage VOH max = VCM max + 1/2 VOD max	LVDS output levels	1.248	1.375	1.602	V
VOL	Output Low Voltage VOL min = VCM min - 1/2 VOD max	LVDS output levels	0.898	1.025	1.252	V
VOD	Output Differential Voltage		247	350	454	mV
VCM	Common Mode Output Voltage		1.125	1.2	1.375	V

Notes:

- 1. Exceeding the absolute maximum ratings may damage the device.
- 2. The device is not guaranteed to function outside its operating ratings.
- $3.\ Guaranteed\ after\ thermal\ equilibrium.$
- 4. Inclusive of initial accuracy, temperature drift, aging, shock, vibration.

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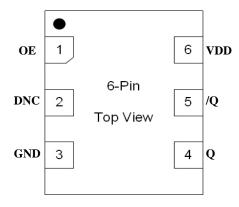
September 27, 2017 MX555AB1-5713 Revision 1.0 tcghelp@microchip.com

Ordering Information

Ordering Part Number	Marking Line 1	Marking Line 3	Shipping	Package
MX555ABB850M000	MX555A	BB8500	Tube	6-Pin 5mm x 3.2mm LGA
MX555ABB850M000-TR	MX555A	BB8500	Tape and Reel	6-Pin 5mm x 3.2mm LGA

Devices are Green and RoHS compliant. Sample material may have only a partial top mark.

Pin Configuration



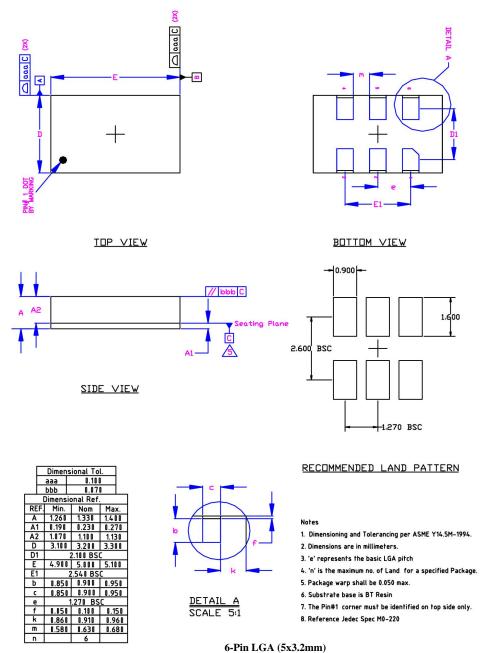
Pin Description

Pin Number	Pin Name	Pin Type	Pin Level	Pin Function
1	OE	I, SE	LVCMOS	Output Enable, disables output to tri-state, 0 = Disabled, 1 = Enabled, 50k Ohms Pull-Up
2	DNC			Make no connection, leave floating.
3	GND	PWR		Power Supply Ground
4, 5	Q, /Q	O, Diff	LVDS	Clock Output Frequency = 850MHz
6	VDD	PWR		Power Supply

Environmental Specifications

Thermal Shock	MIL-STD-883, Method 1011, Condition A	
Moisture Resistance	MIL-STD-883, Method 1004	
Mechanical Shock	MIL-STD-883, Method 2002, Condition C	
Mechanical Vibration	MIL-STD-883, Method 2007, Condition B	
Resistance to Soldering Heat	J-STD-020C, Table 5-2 Pb-free devices (except 2 cycles max)	
Hazardous Substance	Pb-Free / RoHS / Green Compliant	
Solderability	JESD22-B102-D Method 2 (Preconditioning E)	
Terminal Strength	MIL-STD-883, Method 2004, Test Condition D	
Gross Leak	MIL-STD-883, Method 1014, Condition C	
Fine Leak	MIL-STD-883, Method 1014, Condition A2, R1=2x10-8 atm cc/s	
Solvent Resistance	MIL-STD-202, Method 215	

Package Information and Recommended Land Pattern for 6-Pin LGA³



Note:

3. Package information is correct as of the publication date. For updates and most current information, go to www.microchip.com.

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